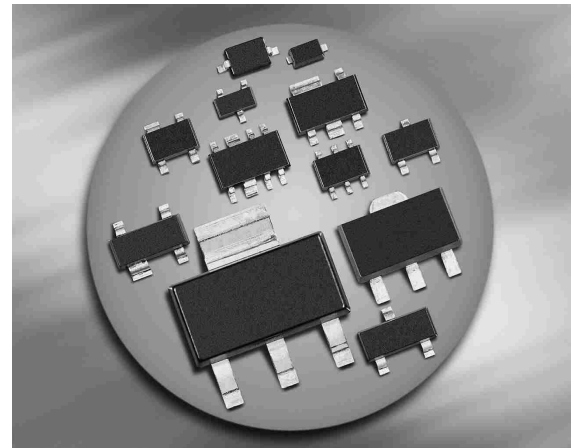


**NPN Silicon AF Transistor**

- For general AF applications
- High collector current
- High current gain
- Low collector-emitter saturation voltage
- Complementary types:  
BC807.../W, BC808.../W (PNP)
- Pb-free (RoHS compliant) package <sup>1)</sup>
- Qualified according AEC Q101



| Type        | Marking | Pin Configuration |       |       |   |   |   | Package |
|-------------|---------|-------------------|-------|-------|---|---|---|---------|
|             |         | 1 = B             | 2 = E | 3 = C | - | - | - |         |
| BC817-16    | 6As     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817K-16*  | 6As     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817-25    | 6Bs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817K-25*  | 6Bs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817-25W   | 6Bs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC817K-25W* | 6Bs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC817-40    | 6Cs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817K-40*  | 6Cs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC817-40W   | 6Cs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC817K-40W* | 6Cs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC818-16W   | 6Es     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC818K-16W* | 6Es     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT323  |
| BC818-25    | 6Fs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC818K-25*  | 6Fs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC818-40    | 6Gs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |
| BC818K-40*  | 6Gs     | 1 = B             | 2 = E | 3 = C | - | - | - | SOT23   |

\* Shrinked chip version

<sup>1</sup>Pb-containing package may be available upon special request

**Maximum Ratings**

| Parameter   | Symbol    | Value             | Unit |    |
|---|-----------|-------------------|------|----|
| Collector-emitter voltage<br>BC817...<br>BC818...   | $V_{CEO}$ | 45<br>25          | V    |    |
| Collector-base voltage<br>BC817...<br>BC818...  | $V_{CBO}$ | 50<br>30          |      |    |
| Emitter-base voltage  | $V_{EBO}$ | 5                 |      |    |
| Collector current   | $I_C$     | 500               | mA   |    |
| Peak collector current  | $I_{CM}$  | 1000              |      |    |
| Base current  | $I_B$     | 100               |      |    |
| Peak base current   | $I_{BM}$  | 200               |      |    |
| Total power dissipation-<br>$T_S \leq 79\text{ °C}$ , BC817, BC818<br>$T_S \leq 115\text{ °C}$ , BC817K, BC818K<br>$T_S \leq 130\text{ °C}$ , BC817W/KW, BC818...W/KW | $P_{tot}$ | 330<br>500<br>250 | mW   |    |
| Junction temperature  | $T_j$     | 150               |      | °C |
| Storage temperature   | $T_{stg}$ | -65 ... 150       |      |    |

**Thermal Resistance**

| Parameter  | Symbol     | Value                                | Unit |
|--|------------|--------------------------------------|------|
| Junction - soldering point <sup>1)</sup><br>BC817, BC818<br>BC817K, BC818K<br>BC817W/KW, BC818W/KW | $R_{thJS}$ | $\leq 215$<br>$\leq 70$<br>$\leq 80$ | K/W  |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

| Parameter  | Symbol        | Values                                      |                                       |                                       | Unit          |
|--|---------------|---|---------------------------------------|---------------------------------------|---------------|
|  |               | min.  | typ.                                  | max.                                  |               |
| <b>DC Characteristics</b>  |               |   |                                       |                                       |               |
| Collector-emitter breakdown voltage<br>$I_C = 10\text{ mA}$ , $I_B = 0$ , BC817...<br>$I_C = 10\text{ mA}$ , $I_B = 0$ , BC818...  | $V_{(BR)CEO}$ | 45<br>25                                    | -<br>-                                | -<br>-                                | V             |
| Collector-base breakdown voltage<br>$I_C = 10\text{ }\mu\text{A}$ , $I_E = 0$ , BC817...<br>$I_C = 10\text{ }\mu\text{A}$ , $I_E = 0$ , BC818...   | $V_{(BR)CBO}$ | 50<br>30                                    | -<br>-                                | -<br>-                                | -             |
| Emitter-base breakdown voltage<br>$I_E = 10\text{ }\mu\text{A}$ , $I_C = 0$  | $V_{(BR)EBO}$ | 5   | -                                     | -                                     | V             |
| Collector-base cutoff current<br>$V_{CB} = 25\text{ V}$ , $I_E = 0$<br>$V_{CB} = 25\text{ V}$ , $I_E = 0$ , $T_A = 150^\circ\text{C}$  | $I_{CBO}$     | -<br>-                                      | -<br>-                                | 0.1<br>50                             | $\mu\text{A}$ |
| Emitter-base cutoff current<br>$V_{EB} = 4\text{ V}$ , $I_C = 0$   | $I_{EBO}$     | -   | -                                     | 100                                   | nA            |
| DC current gain <sup>1)</sup><br>$I_C = 100\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.16}$<br>$I_C = 100\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.25}$<br>$I_C = 100\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.40}$<br>$I_C = 300\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.16}^{2)}$<br>$I_C = 300\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.25}^{2)}$<br>$I_C = 300\text{ mA}$ , $V_{CE} = 1\text{ V}$ , $h_{FE}\text{-grp.40}^{2)}$<br>$I_C = 500\text{ mA}$ , $V_{CE} = 1\text{ V}$ , all $h_{FE}\text{-grps.}^{3)}$ | $h_{FE}$      | 100<br>160<br>250<br>60<br>100<br>170<br>40 | 160<br>250<br>350<br>-<br>-<br>-<br>- | 250<br>400<br>630<br>-<br>-<br>-<br>- | -             |
| Collector-emitter saturation voltage <sup>1)</sup><br>$I_C = 500\text{ mA}$ , $I_B = 50\text{ mA}$   | $V_{CEsat}$   | -   | -                                     | 0.7                                   | V             |
| Base emitter saturation voltage <sup>1)</sup><br>$I_C = 500\text{ mA}$ , $I_B = 50\text{ mA}$  | $V_{BEsat}$   | -   | -                                     | 1.2                                   |               |

<sup>1)</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$ 
<sup>2)</sup>For all BC817 and BC818 subtypes

<sup>3)</sup>For all BC817K and BC818K subtypes

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter  | Symbol   | Values |          |      | Unit |
|--|----------|--------|----------|------|------|
|  |          | min.   | typ.     | max. |      |
| <b>AC Characteristics</b>  |          |        |          |      |      |
| Transition frequency<br>$I_C = 50\text{ mA}, V_{CE} = 5\text{ V}, f = 100\text{ MHz}$                                    | $f_T$    | -      | 170      | -    | MHz  |
| Collector-base capacitance<br>$V_{CB} = 10\text{ V}, f = 1\text{ MHz}^1)$<br>$V_{CB} = 10\text{ V}, f = 1\text{ MHz}^2)$ | $C_{cb}$ | -      | 6<br>3   | -    | pF   |
| Emitter-base capacitance<br>$V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}^1)$<br>$V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}^2)$ | $C_{eb}$ | -      | 60<br>40 | -    |      |

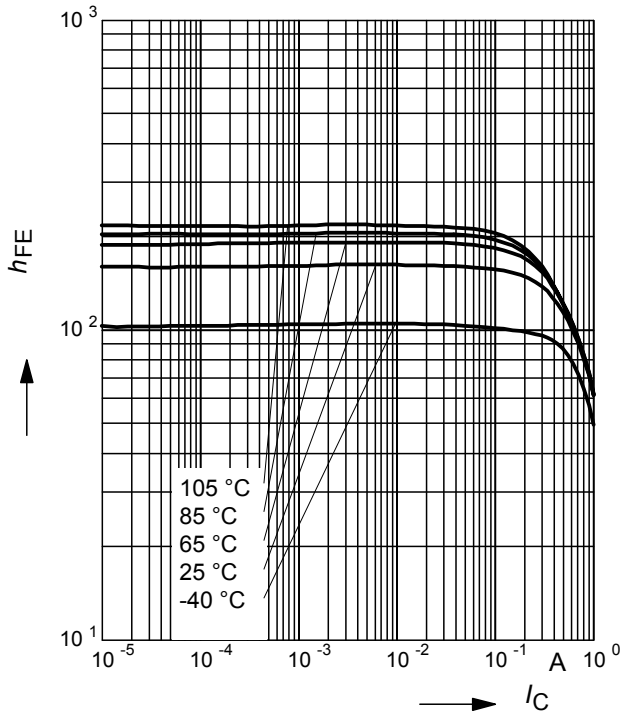
<sup>1</sup>For all BC817 and BC818 subtypes

<sup>2</sup>For all BC817K and BC818K subtypes

**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 1\text{ V}$

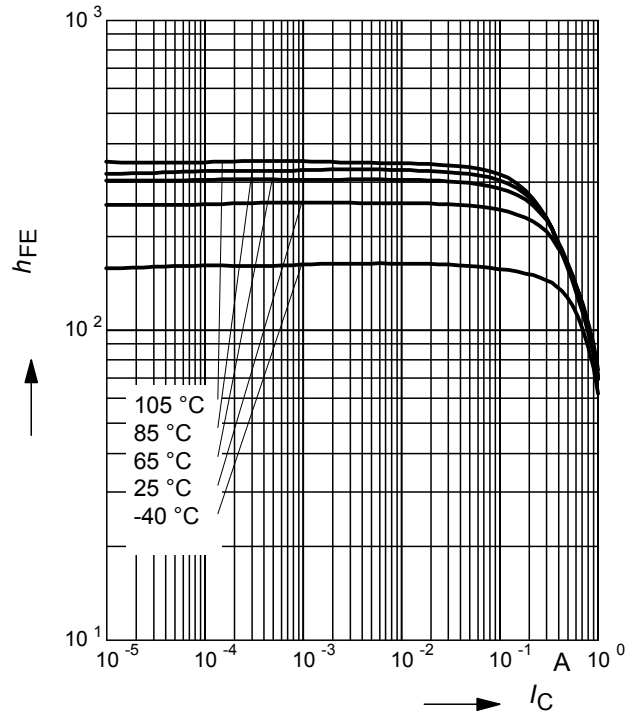
$h_{FE}\text{-grp.16}$



**DC current gain  $h_{FE} = f(I_C)$**

$V_{CE} = 1\text{ V}$

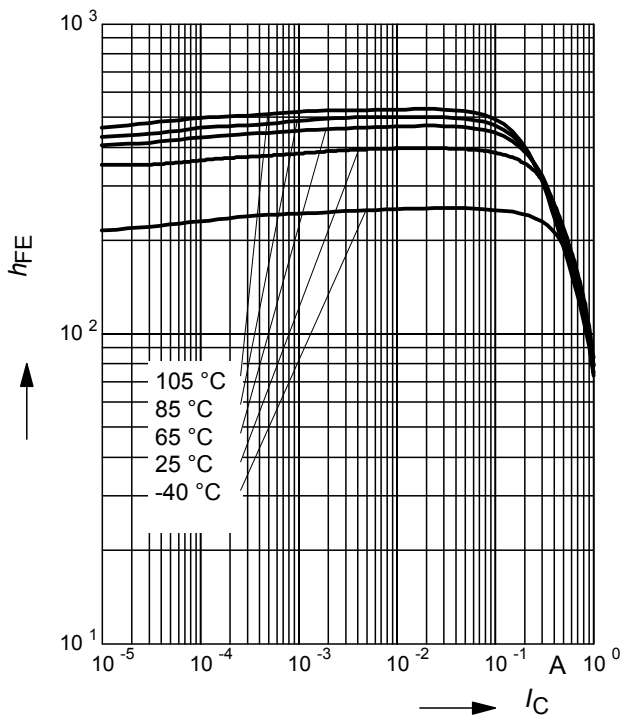
$h_{FE}\text{-grp.25}$



**DC current gain  $h_{FE} = f(I_C)$**

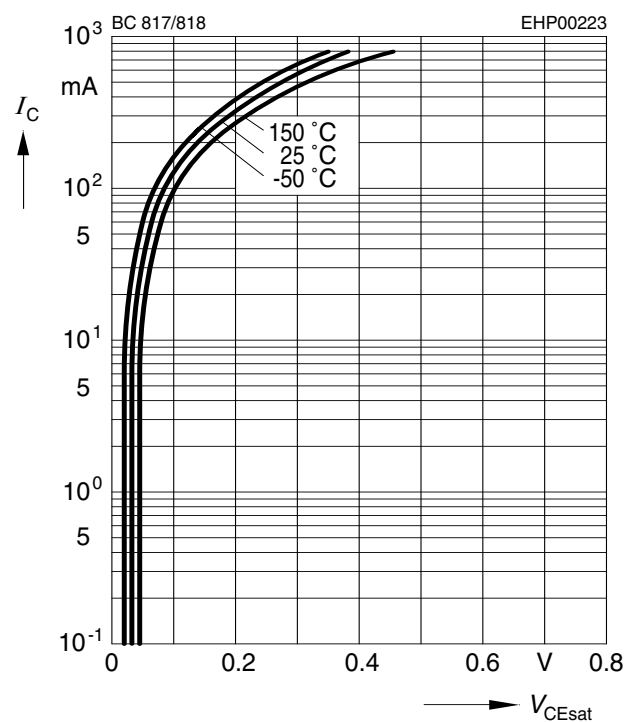
$V_{CE} = 1\text{ V}$

$h_{FE}\text{-grp.40}$



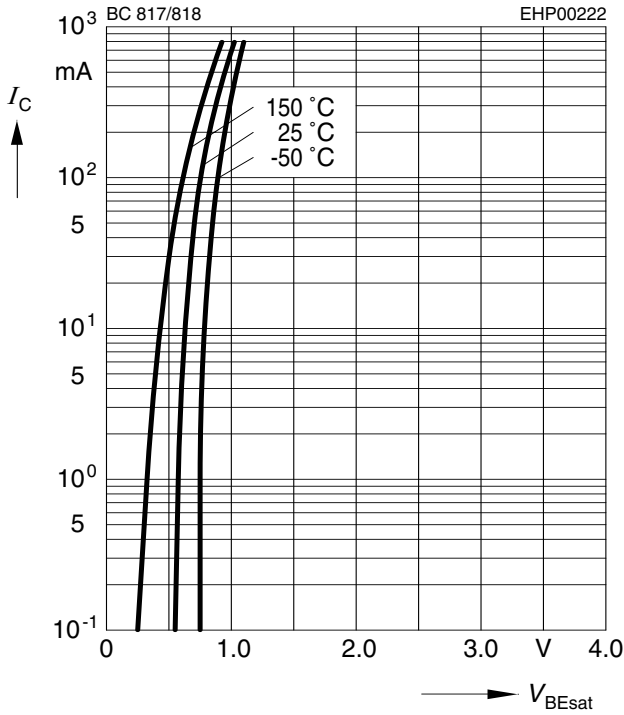
**Collector-emitter saturation voltage**

$I_C = f(V_{CEsat}), h_{FE} = 10$



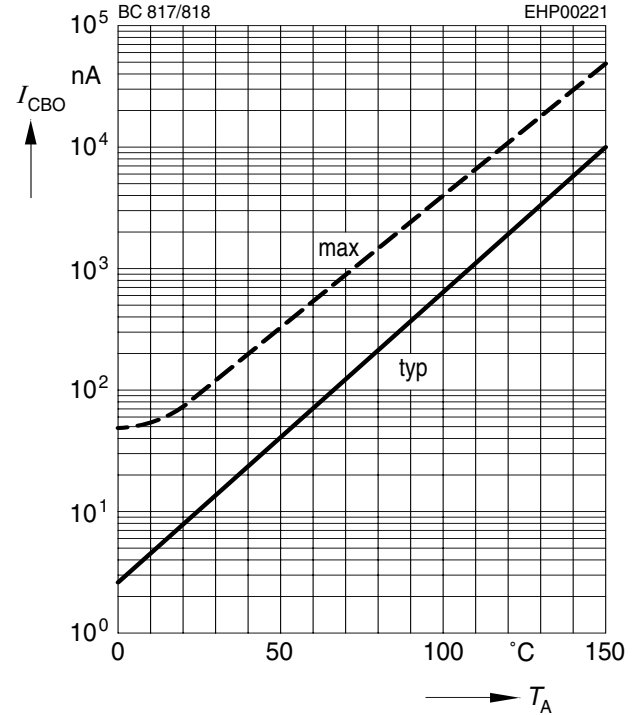
**Base-emitter saturation voltage**

$I_C = f(V_{BEsat}), h_{FE} = 10$



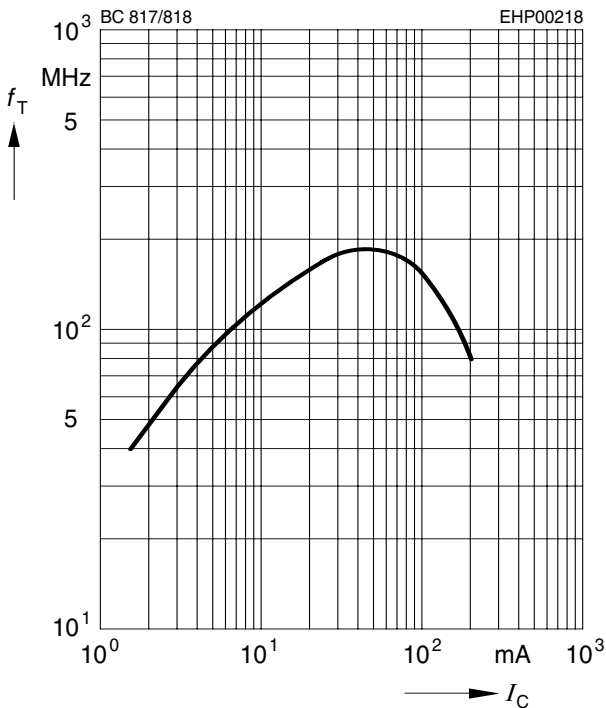
**Collector cutoff current  $I_{CBO} = f(T_A)$**

$V_{CBO} = 25 V$



**Transition frequency  $f_T = f(I_C)$**

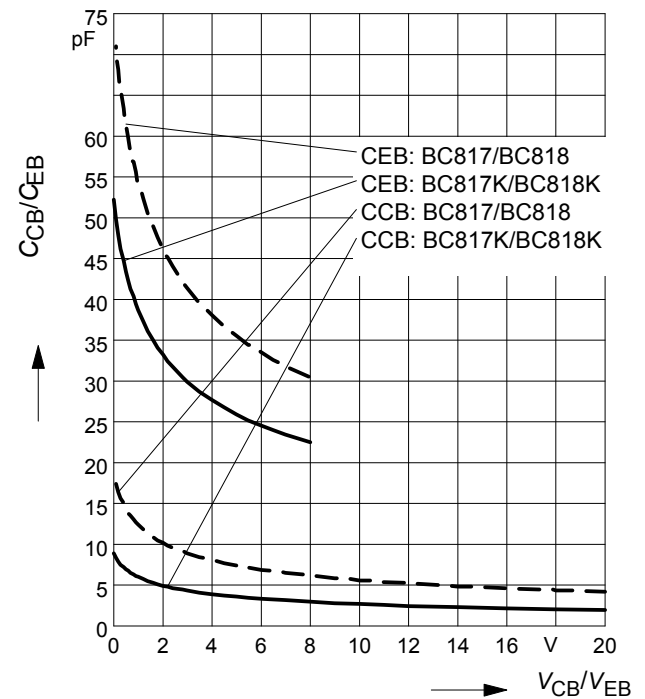
$V_{CE} = \text{parameter in V}, f = 2 \text{ GHz}$



**Collector-base capacitance  $C_{cb} = f(V_{CB})$**

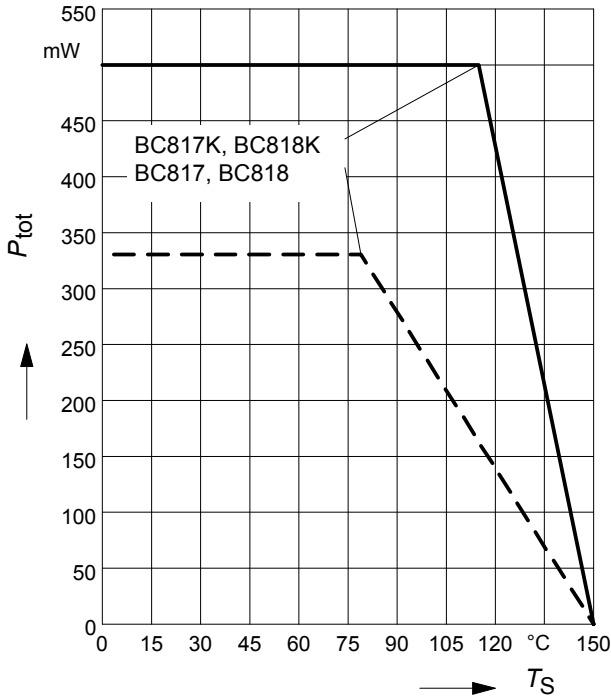
**Emitter-base capacitance  $C_{eb} = f(V_{EB})$**

BC817, BC818: - - - , BC817K, BC818K: —



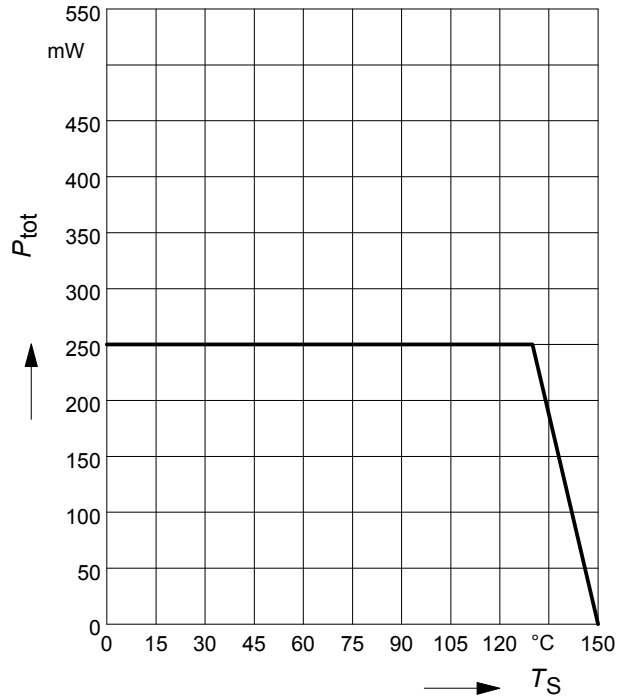
**Total power dissipation  $P_{tot} = f(T_S)$**

BC817, BC818: - - - , BC817K, BC818K: —



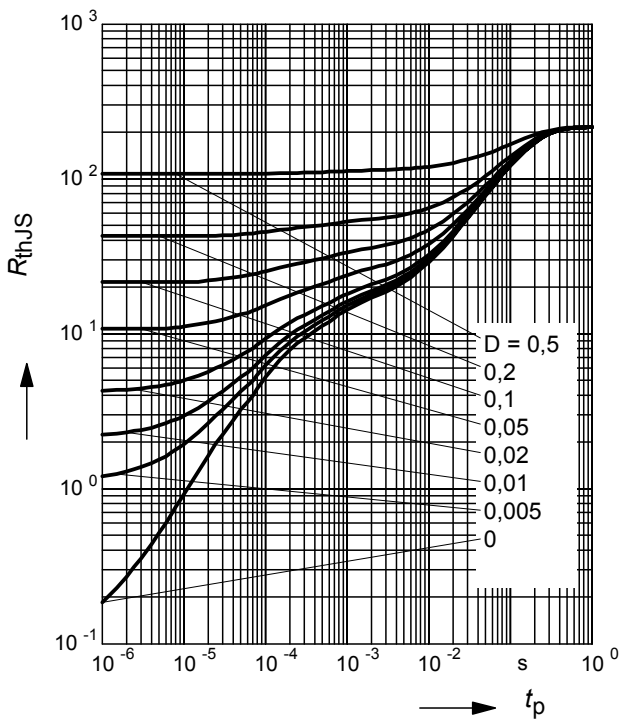
**Total power dissipation  $P_{tot} = f(T_S)$**

BC817W/KW, BC818W/KW



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

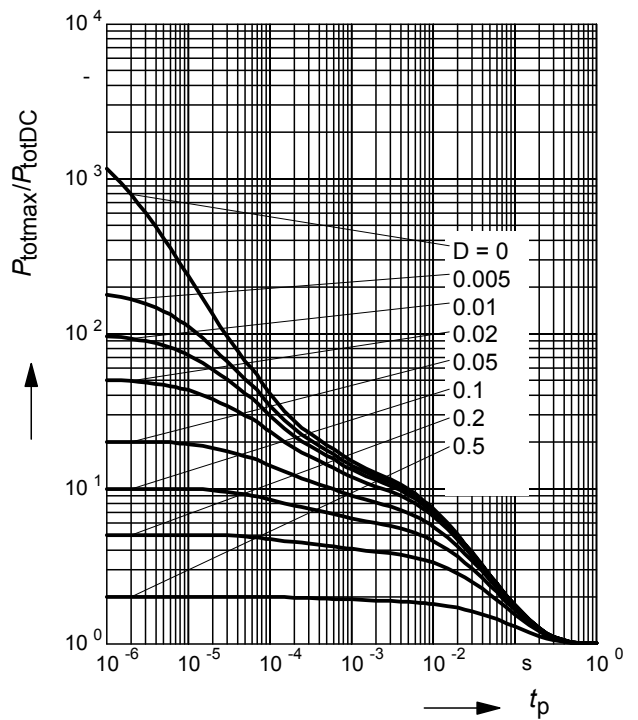
BC817, BC818



**Permissible Pulse Load**

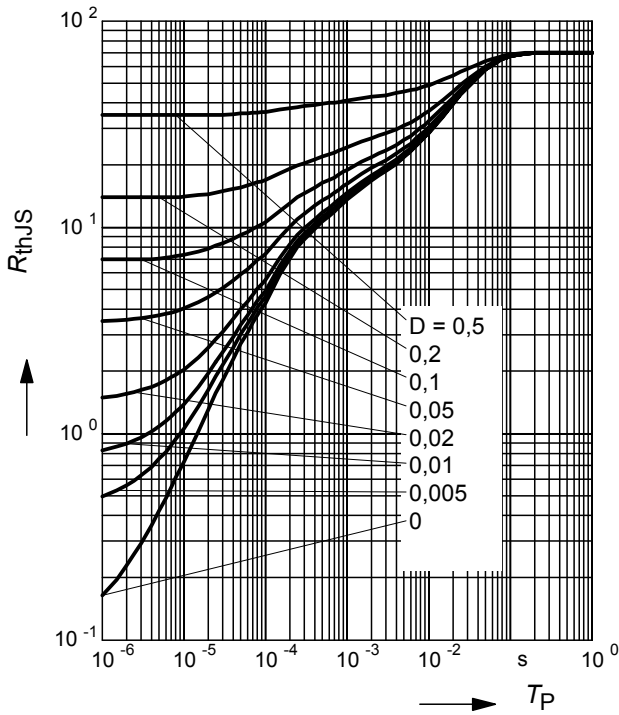
$P_{totmax}/P_{totDC} = f(t_p)$

BC817, BC818



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

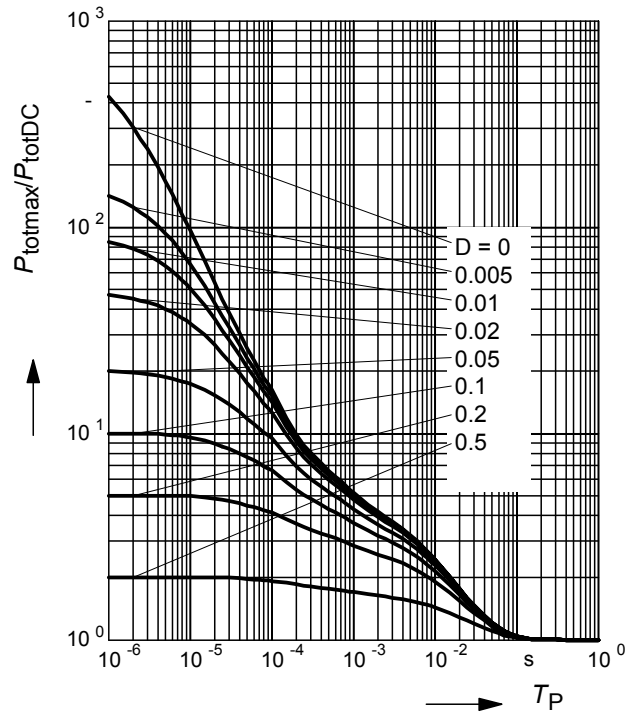
BC817/K, BC818/K



**Permissible Pulse Load**

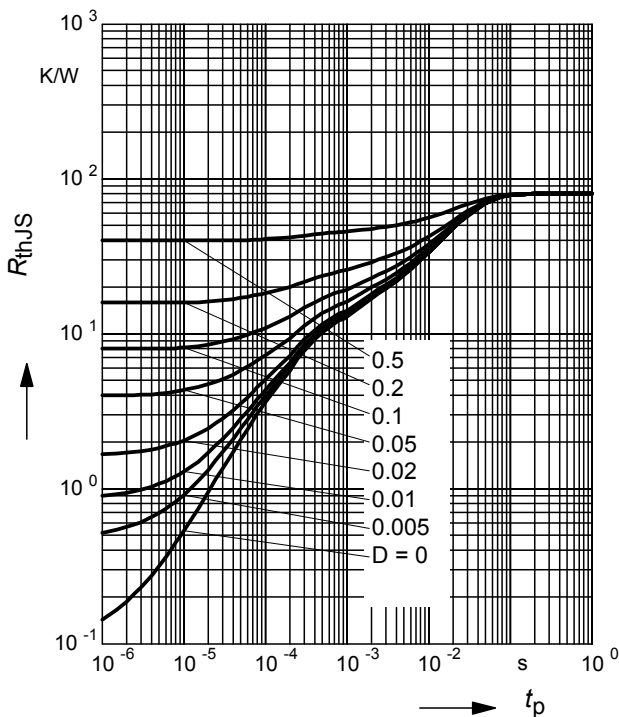
$P_{totmax}/P_{totDC} = f(t_p)$

BC817K, BC818K



**Permissible Puls Load  $R_{thJS} = f(t_p)$**

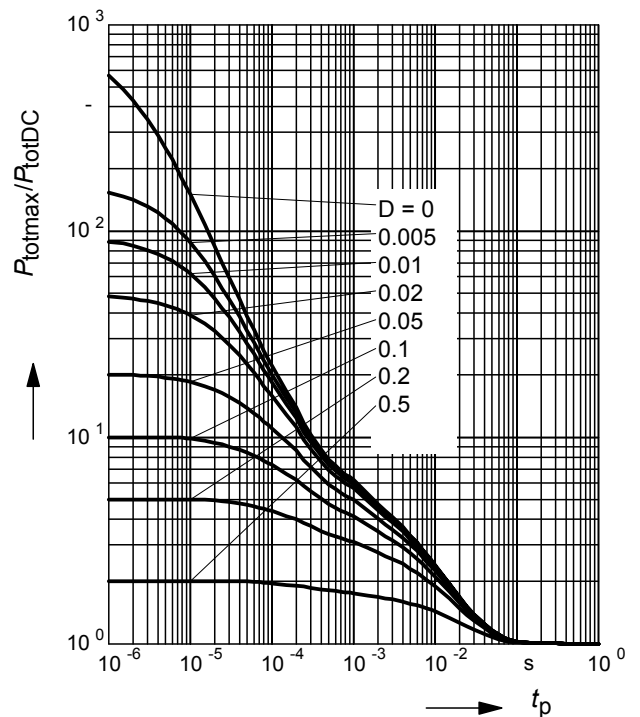
BC817W/KW, BC818W/KW



**Permissible Pulse Load**

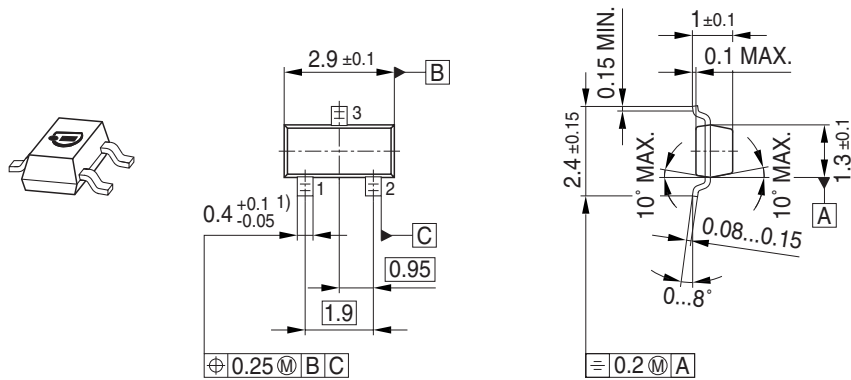
$P_{totmax}/P_{totDC} = f(t_p)$

BC817W/KW, BC818W/KW

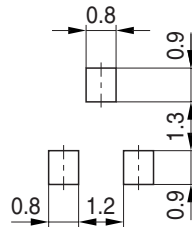




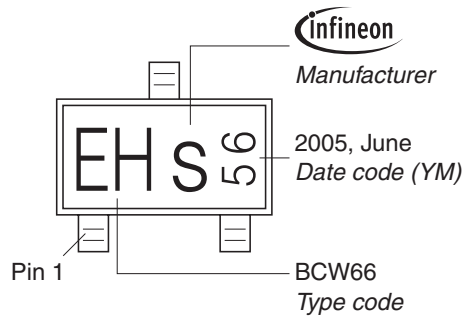
Package Outline



Foot Print

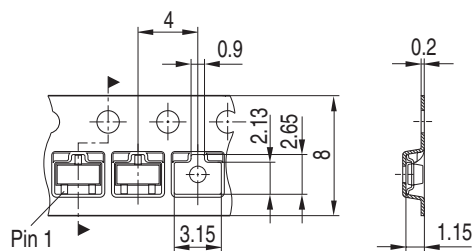


Marking Layout (Example)

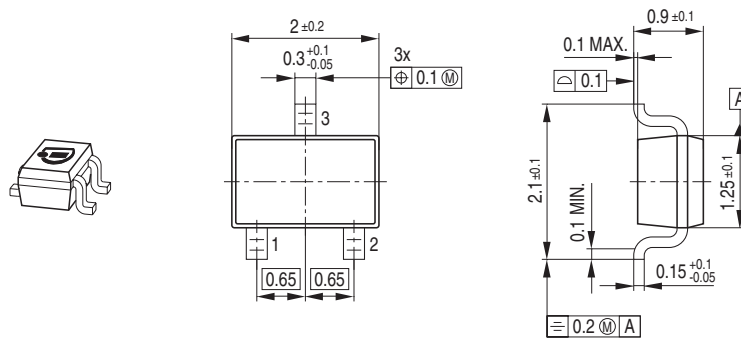


Standard Packing

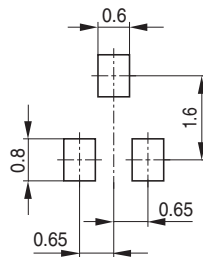
Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



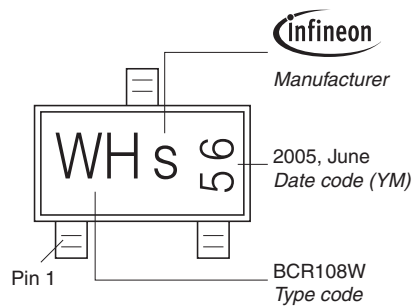
Package Outline



Foot Print

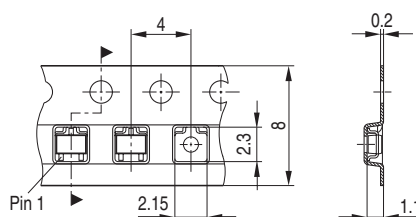


Marking Layout (Example)



Standard Packing

Reel  $\varnothing$ 180 mm = 3.000 Pieces/Reel  
 Reel  $\varnothing$ 330 mm = 10.000 Pieces/Reel



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